

IN THE SPECIFICATION

Please amend the specification as follows:

Please replace the paragraph starting at page 15, line 9 with the following paragraph:

In one embodiment, the mold ~~402~~ 210 includes borophosphosilicate glass (BPSG). In an embodiment, the mold 210 includes phosphosilicate glass (PSG). In an embodiment, the mold 210 includes tetraethylortho-silicate (TEOS). In one embodiment, the mold 210 includes SA TEOS. In an embodiment, the mold 210 includes SiLK (which is a registered trademark of Dow Chemical company for a low-k dielectric resin). Those skilled in the art will recognize that a wide variety of materials can be substituted for the different mold material described here, without departing from the scope of the appended claims.